

N-Channel Power MOSFET

1000V, 2.5A, 6Ω

FEATURES

- 100% avalanche tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- AC/DC LED Lighting
- **Power Supply**
- Power Meter

KEY PERFORMANCE PARAMETERS				
PARAMETER	VALUE	UNIT		
$V_{ extsf{DS}}$	1000	V		
R _{DS(on)} (max)	6	Ω		
Q_g	19	nC		







Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER	SYMBOL	Limit	UNIT	
Drain-Source Voltage	V _{DS}	1000	V	
Gate-Source Voltage	V _{GS}	±30	٧	
Continuous Drain Current (Note 1) T _C = 25°C		2.5		
T _C = 100°C	l _D	1.57	A	
Pulsed Drain Current (Note 2)	I _{DM}	10	А	
Total Power Dissipation @ $T_C = 25^{\circ}C$	P _{DTOT}	99	W	
Single Pulse Avalanche Energy (Note 3)	E _{AS}	20	mJ	
Single Pulse Avalanche Current (Note 3)	I _{AS}	1.4	А	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	- 55 to +150	°C	

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	Limit	UNIT	
Junction to Case Thermal Resistance	R _{eJC}	1.26	°C/W	
Junction to Ambient Thermal Resistance	R _{OJA}	62	°C/W	

Thermal Performance Note: Reja is the sum of the junction-to-case and case-to-ambient thermal resistances. The casethermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. R_{BJA} shown below for single device operation on FR-4 PCB in still air.

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ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV _{DSS}	1000			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	$V_{GS(TH)}$	3.5	4.5	5.5	V
Gate Body Leakage	$V_{GS} = \pm 30 V$, $V_{DS} = 0 V$	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = 1000V, V_{GS} = 0V$	I _{DSS}			1	μΑ
Drain-Source On-State Resistance (Note 4)	V _{GS} = 10V, I _D = 1.25A	R _{DS(on)}		5.6	6	Ω
Dynamic (Note 5)		l				"
Total Gate Charge		Qg		19		
Gate-Source Charge	$V_{DS} = 800V, I_{D} = 2.5A,$	Q _{gs}	(6		nC
Gate-Drain Charge	$V_{GS} = 10V$	Q_{gd}		10		
Input Capacitance		C _{iss}	1	664		
Output Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz	C _{oss}	<i>J '</i>	40		pF
Reverse Transfer Capacitance	1 = 1.0001112	C_{rss}		17		
Gate Resistance	f = 1.0MHz, open drain	R_g		2.2		Ω
Switching (Note 6)						
Turn-On Delay Time		t _{d(on)}		45		
Turn-On Rise Time	$V_{DD} = 500V, R_{G} = 25\Omega,$	t _r		25		
Turn-Off Delay Time	$I_D = 1.25A$, $V_{GS} = 10V$	$t_{d(off)}$		70		ns
Turn-Off Fall Time		t _f		28		
Source-Drain Diode						
Forward Voltage (Note 4)	$I_S = 2.5A, V_{GS} = 0V$	V _{SD}		-	1.4	V
Reverse Recovery Time	$V_R = 100V, I_S = 2.5A$	t _{rr}		378		ns
Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	Q_{rr}		1.62		μC

Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. L = 20mH, I_{AS} = 1.4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 4. Pulse test: PW ≤ 300μs, duty cycle ≤ 2%
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

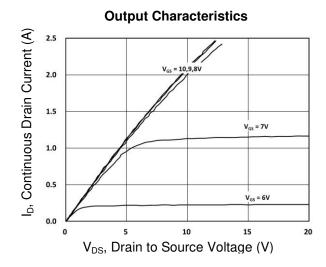
ORDERING INFORMATION

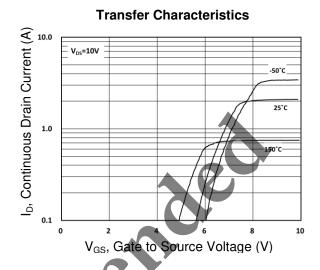
PART NO.	PACKAGE	PACKING	
TSM3N100CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel	

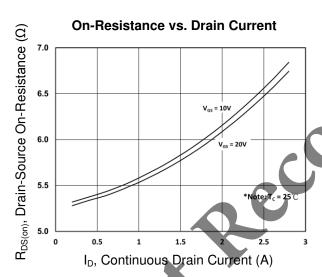


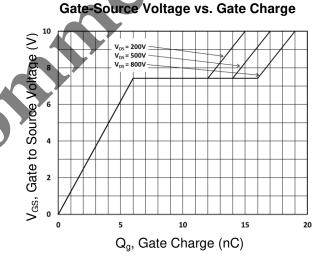
CHARACTERISTICS CURVES

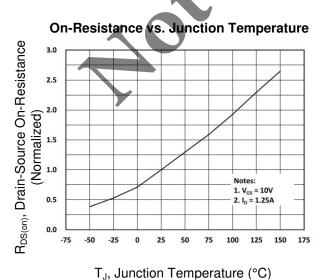
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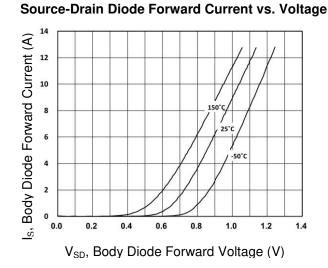












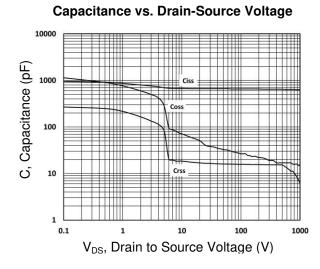
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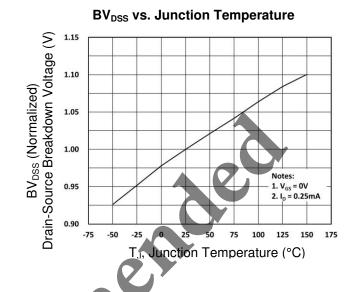
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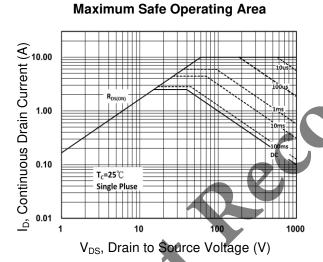


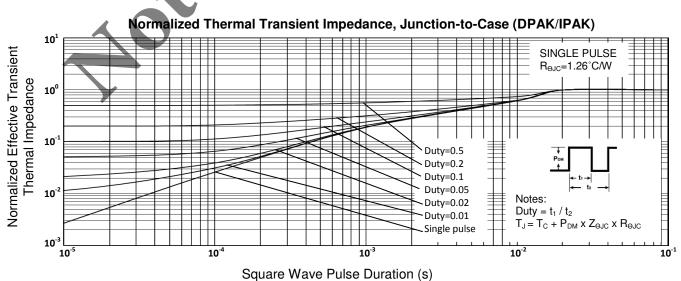
CHARACTERISTICS CURVES

 $(T_C = 25^{\circ}C \text{ unless otherwise noted})$





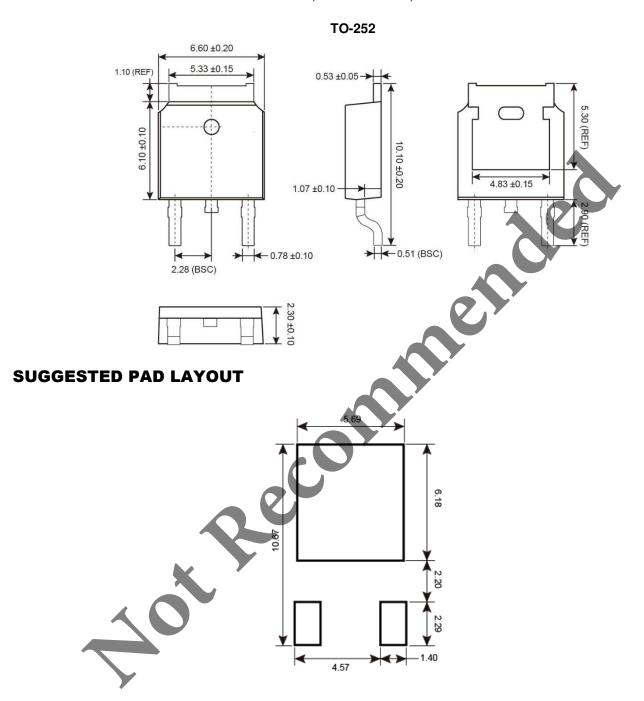




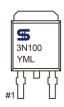
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PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



MARKING DIAGRAM



Y = Year Code

M = Month Code for Halogen Free Product

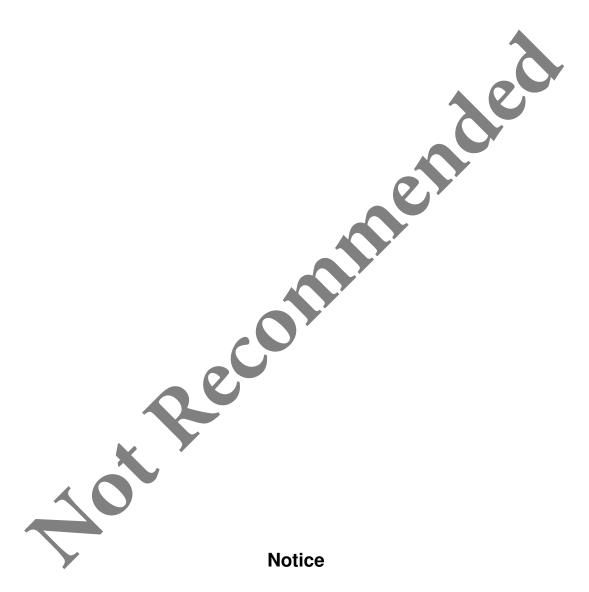
O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug

W = Sep X = Oct Y = Nov Z = Dec

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L = Lot Code $(1 \sim 9, A \sim Z)$





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